

PKG and Interconnect COM Impact Analysis and “What-ifs”

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Contributors

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Main Presentation Outcome

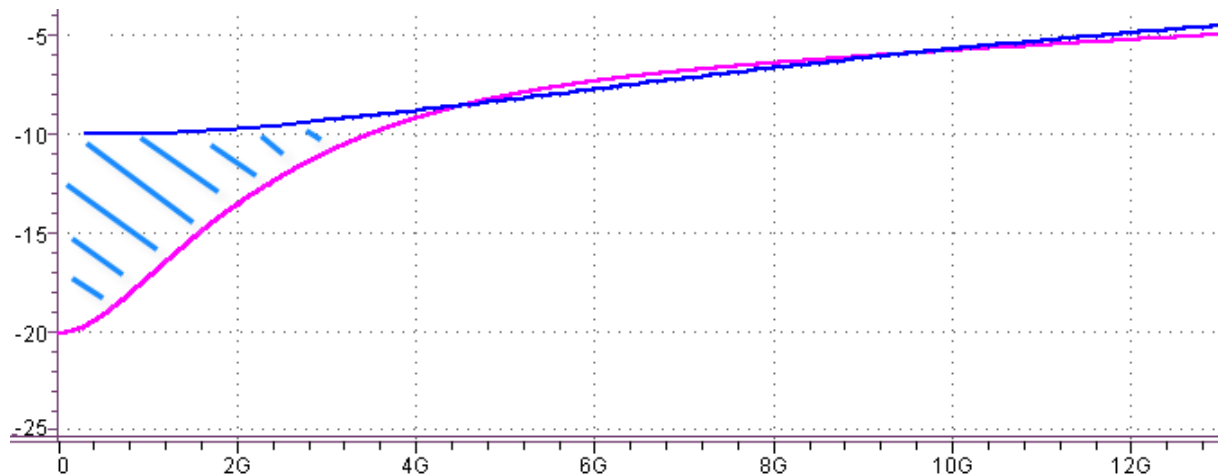
- This presentation will provide a correction for the PKG return loss as included in the COM code.
- It will be shown that given the corrected return loss, COM result increases and KR4 targets can be met.
- This presentation also provides resolution for comments: 44-48; 50-54; 56-58

D1.2 Status description

- 802.3bj KR4 targets 35dB @ fb/2 interconnects with FEC.
- D1.2 incorporated package and interconnect return loss limits.
 - Package return loss limit was based on package ball discontinuity, 0.25pF assumed die capacitance and package manufacturing tolerance.
 - Interconnect return loss was suggested to follow OIF-3.0 limit.
- D1.2 incorporated a reference package insertion loss model.
- Running “IBM 35” interconnect D1.2 return loss returned a marginal COM result after tweaking the Tx to best case.
- Package insertion loss model (with new PKG RL) has an influence of 1-1.5dB

So what is wrong with the D1.2 PKG RL model?

- The package return loss equation did not represent the real reflection from a package, taking non reasonable margin at the low frequency.
- The package insertion loss was accounted for twice (Tx, Rx), while 800mV should be defined at TP0 (with a test load)
➔ If including a package IL model, include only Rx PKG insertion loss - Cont. on slide 17



Proposed PKG Return Loss Equation

- The proposed package return loss equation (purple/lilac curve) is:

$$Z_{PKG} = \frac{-w^2 * a_2 + i * wa1 + a0}{-i * w^3 * b_3 - b_2 * w^2 + i * b_1 * w + 1}$$

$$a2 = 5.112E-20$$

$$a1 = 3.2733E-09$$

$$a0 = 41$$

$$b3 = 8.9856E-33$$

$$b2 = 1.0895E-21$$

$$b1 = 3.729E-11$$

$$PKG_RetLoss = \frac{Z_{PKG} - 50}{Z_{PKG} + 50} * \exp^{-i*\pi}$$

- The equation resembles the phase of a reflection from a real package as well as provides the required return loss limit.

TP0a/TP5a Return Loss Measurements Limit

- The return loss at TP0a/tp5a as measured through the test fixture should meet:

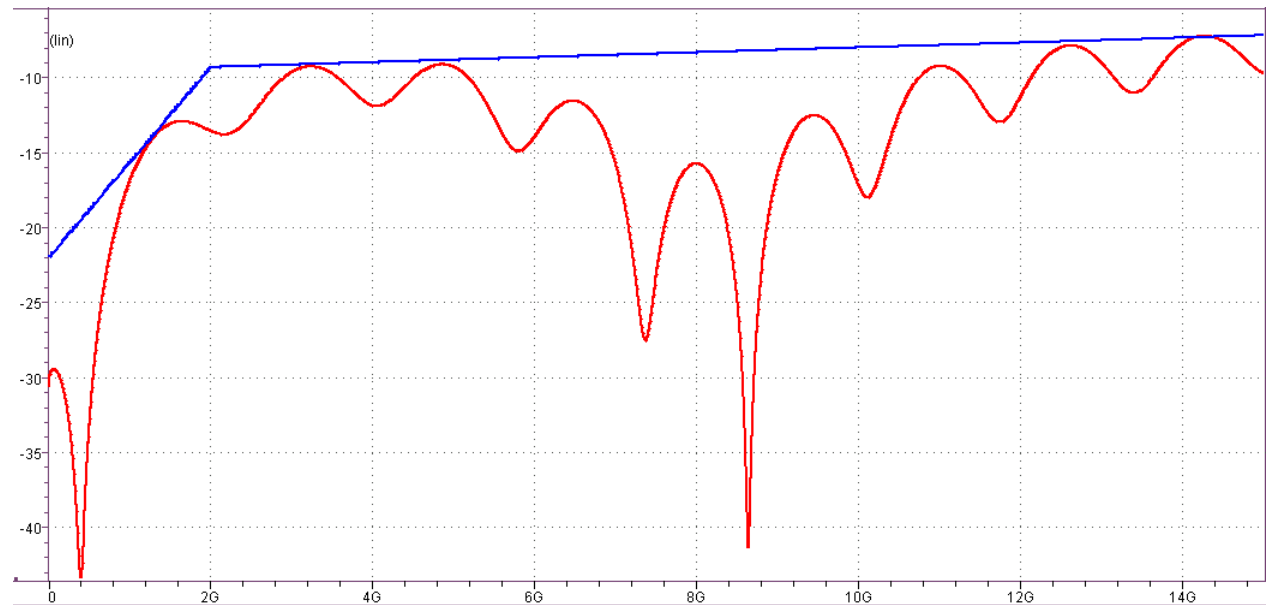
$$6.25 * f - 22$$

$$0.05 \leq f \leq 2$$

$$0.163 * f - 9.62$$

$$2 \leq f \leq 13 \text{ (10 for KP4)}$$

f in GHz



Patel 30dB through interconnect

- “What if” analysis performed on the “Patel” 30dB through interconnect.

| PKG return loss | PKG insertion loss | Interconnect return loss | COM result |
|-----------------|--------------------|--------------------------|----------------------------------|
| OIF | D1.2 | Original | 4.4dB (10^{-5}) |
| D1.2 | D1.2 | Original | 4.2 (10^{-5}) |
| Slide #6 | D1.2 | Original | 4.88dB (10^{-5}) |
| Slide #6 | D1.2 | Original | 5.85dB (10^{-5}) No XTalk |

IBM ~36dB interconnect

- “What if” analysis performed on 35db_Loss_channel.zip.

| PKG return loss | PKG insertion loss | Interconnect return loss | COM result |
|-----------------|--------------------|--------------------------|--|
| D1.2 | D1.2 | Original | 2.95dB Tweaking the Tx settings |
| Slide #6 | D1.2 | Original | 1.66dB (10^{-5}) |
| Slide #6 | D1.2 | Original | 3.21dB (10^{-5}) – Tweaking the Tx settings |
| Slide #6 | D1.2 | Magnitude lowered by 20% | 3.51dB (10^{-5}) – Tweaking the Tx settings |

- 6-9mV available signal is “scary” low...
- With very low signal every “minor” effect is magnified. This indicates a border line case putting us on an “edge of a cliff”
- Results indicate the PKG return loss and IL models are “good enough” to meet target.
- It is most important to verify that the interconnect provides the required COM value under worst case manufacturing tolerance.

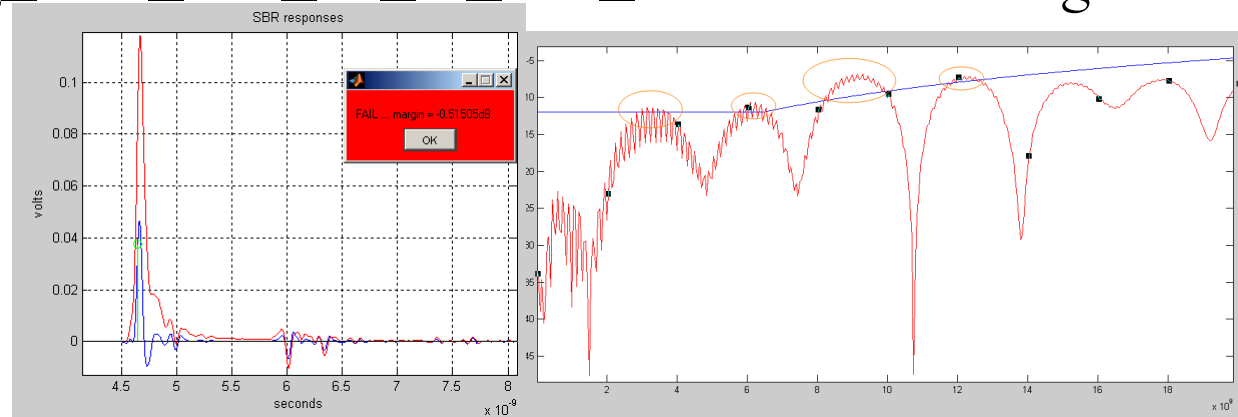
A Spotlight on Interconnect Return loss

- An **informative** interconnect return loss was adopted into D1.2.
- Main intention was to provide guidelines to interconnect design requirements.
- The actual interconnect return loss influence is included in the **normative** COM methodology.
- In order to allow a positive COM margin / operation with 25Gbps/lane NRZ the interconnect insertion loss is just a part of the whole picture...

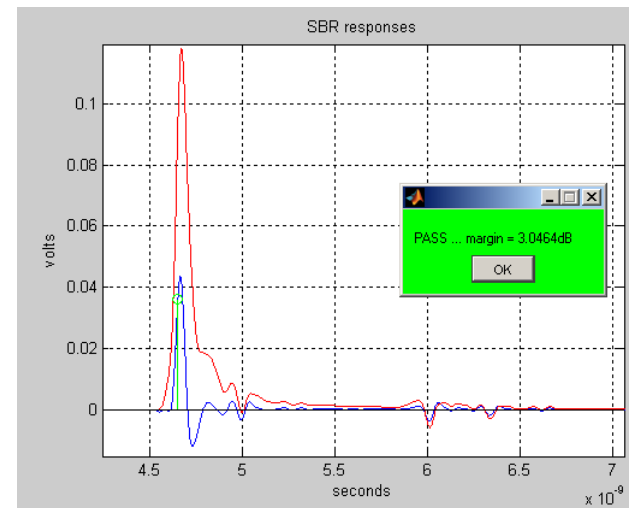
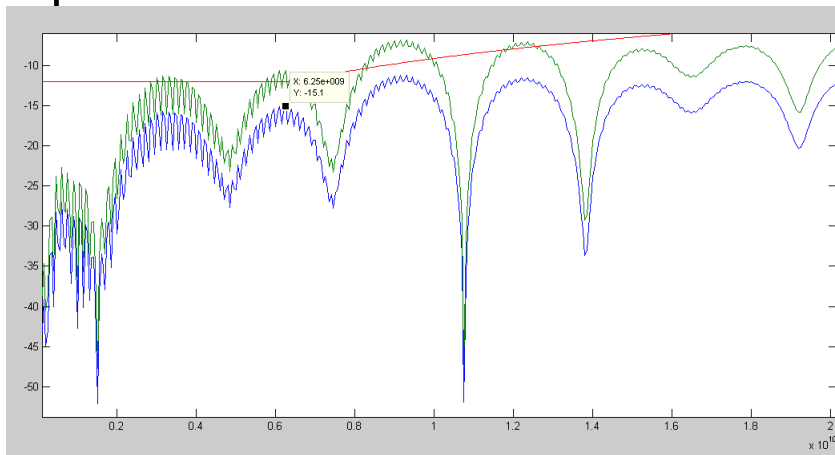
A Spotlight on Interconnect Return loss

- Return Loss Example (1E-12)

- FCI_CC_Long_Link_Pair_15_to_Pair_7 Returns a failing COM number.



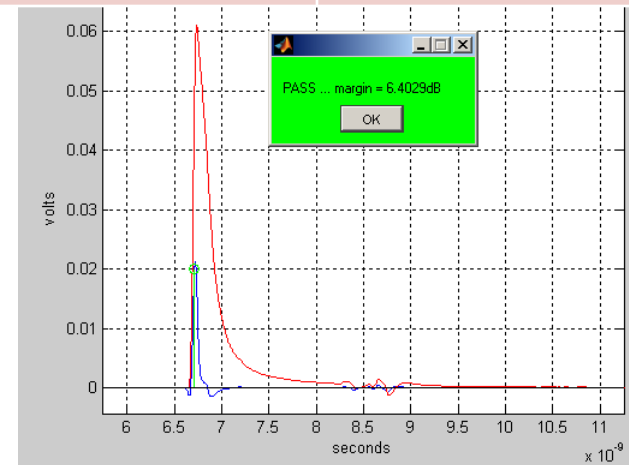
- Update the interconnect RL...



Strada Whisper Interconnects

- Running Strada Whisper interconnects with PKG RL, PKG IL and full XTalk. Modeling.

| Interconnect | PKG insertion loss | PKG RL | COM result |
|------------------|--------------------|---------|------------|
| 42p8in - Meg6 | D1.2 | Slide 6 | 6.4dB |
| 29.8dB – Nelco 6 | D1.2 | D1.2 | 4.18dB |
| 29.8dB – Nelco 6 | D1.2 | Slide 6 | 4.56dB |



Calculated effective voltage transfer ratio using a standard specified RL.

- Taking into account an 800mV (at the ball) + ~30dB channel + ~2.5dB Rx PKG → 1010...Signal before equalization = 19mV
- Taking into account 1mV RMS noise at the receiver (sigma_r) → There is no room for any other distortion source...
- Looking at the way SDD21 is updated with return losses impact:

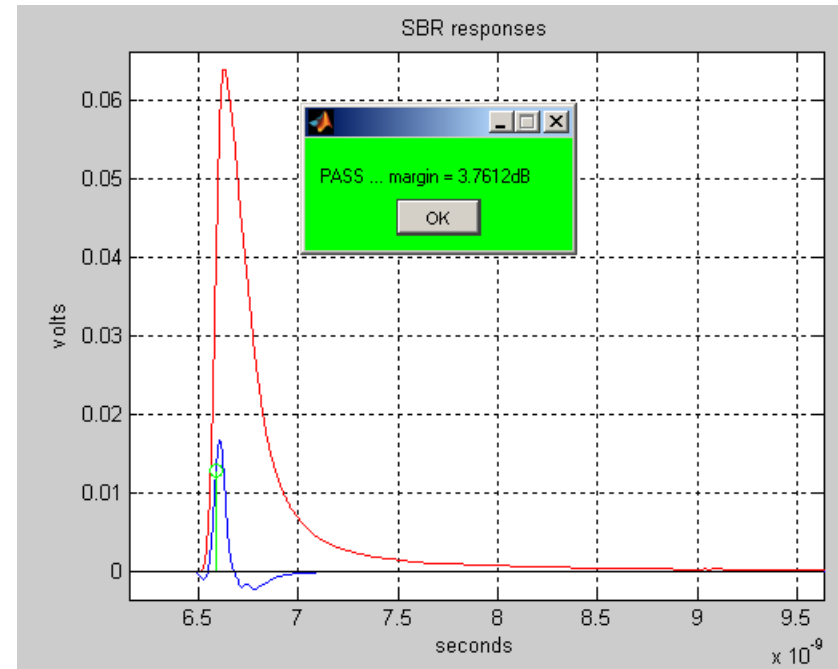
$$H_{21proposed1} = \frac{S_{21}}{1 - S_{11}\Gamma_{TX} - S_{22}\Gamma_{RX} - S_{21}S_{12}\Gamma_{TX}\Gamma_{RX} + S_{11}\Gamma_{TX}S_{22}\Gamma_{RX}} \quad \text{Gain based on waves}$$

$$H_{21proposed3} = \frac{S_{21} (1 + \Gamma_{RX})}{1 - S_{11}\Gamma_{TX} - S_{22}\Gamma_{RX} - S_{21}S_{12}\Gamma_{TX}\Gamma_{RX} + S_{11}\Gamma_{TX}S_{22}\Gamma_{RX}}$$

- It is essential to minimize any other external distortion sources.

~30dB channel vs. 25Gbps

- So, Can a 30dB channel really work @ 25Gbps?
- An ideal (sampled, not simulated) ~32dB channel COM results:
 - VTF = 3 ; Inclusion of PKG
 - Main difference is a great interconnect return loss.



The Package Return Loss is Based on Physical Design Realities

- Assumed capacitance was taken from numerous former presentations (250fF).
- The die and ball discontinuities influence the return loss curves.
- The return loss curves are highly influenced by the discontinuities at the ball and the die and represent no added discontinuity along the package trace.
- The return loss curves take into account package traces of various length.
- Conclusion: The suggested return loss is based on ball-discontinuity extraction and die parasitic capacitance.

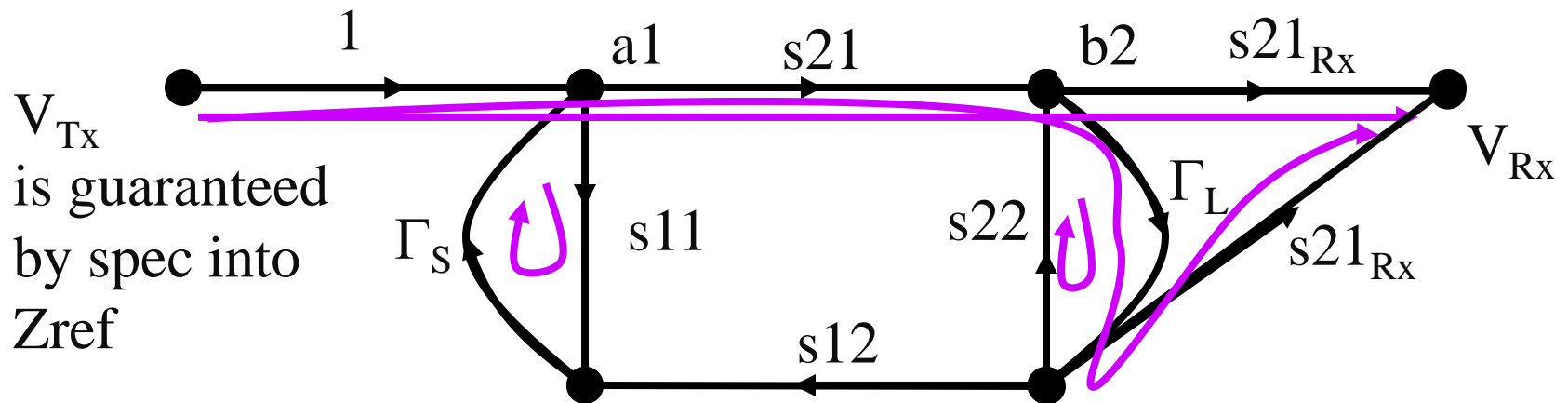
The PKG Insertion Loss Model

- A non-causal behavior can be observed with “problematic” interconnects (mainly when including return loss...).
- The PKG model integrates no package level crosstalk.
- In ran_01_0712.pdf it a Rx PKG COM impact of 3dB was assumed.
- Recommendation: Given all the above inaccuracies, Remove the PKG insertion loss model and integrate an extra xdB required margin (1.5dB as an initial number).
(up to the floor to decide?!)
 - Note: A more complicated & accurate model is ready for integration if needed.

Inclusion of a Tx Side Package

- The spec guaranties a specific minimal voltage (800mV) at the device balls (or at TP0a) when driving a Zref.
- Inclusion of a Tx side PKG does not fulfill this requirement.
- Exercise: Driving an ideal load will supply Vload to be $V_S * S_{PKG_{Tx}}$ → The minimal requirement is to multiply V_{drv} by the Tx_{PKG} inverse transfer function.
- Doing so is the same as using the graph on the next slide

Forward + reverse wave paths



$$\frac{V_{Rx}}{V_{Tx}} = \frac{s21 * (s21_{Rx}) * (1 + \Gamma_{Rx})}{1 - s11 * \Gamma_{Tx} - s22 * \Gamma_{Rx} - s21 * s12 * \Gamma_{Tx} * \Gamma_{rx} + s11 * s22 * \Gamma_{Tx} * \Gamma_{rx}}$$

- Resolution for comment 57, 54: Define transmitter and far end aggressor @TP0 and use the above equation to calculate the voltage transfer function (VTF#3) – can remove $S21_{Rx}$ if so decided.
- $\Gamma_{Tx} = \Gamma_{Rx} = \text{Suggested in slide\#9}$

KR4 Interference tolerance testing

- Intended to provide resolution for comment 46
- Recommend adding COM requirement per interconnect (an initial max value of 4.5dB (if PKG insertion loss model removed / 3dB if PKG IL exists) is recommended.
- A higher COM value can be determined for shorter channels which are meant to have higher noise.
- Since the test equipment is characterized by a great return loss: A switch to be added to the COM code to bypass the influence of the Tx PKG RL / add a test equipment characteristic RL avoiding under-stress :

$$H_{21\text{proposed}3} = \frac{S_{21} (1 + \Gamma_{RX})}{1 - S_{11}\Gamma_{TX} - S_{22}\Gamma_{RX} - S_{21}S_{12}\Gamma_{TX}\Gamma_{RX} + S_{11}\Gamma_{TX}S_{22}\Gamma_{RX}}$$

Conclusions / Recommendations

- Target Interconnect can be met with suggested PKG return loss.
- Target Interconnects can be met with current D1.2 PKG IL model.
- Comments 51, 52, 44, 45 - PKG return loss model in COM: Use the equation from slide 6.
- Comments 47, 48: Decide if to remove the package insertion loss model and include an additional COM requirement according to slide 16.
- Comment 46 (Com for interference tol test): follow slide #19
- Comments 50,53,56,58: Measured return loss: follow the equation from slide 7.
- Comments 54, 57: Please refer to slide 16

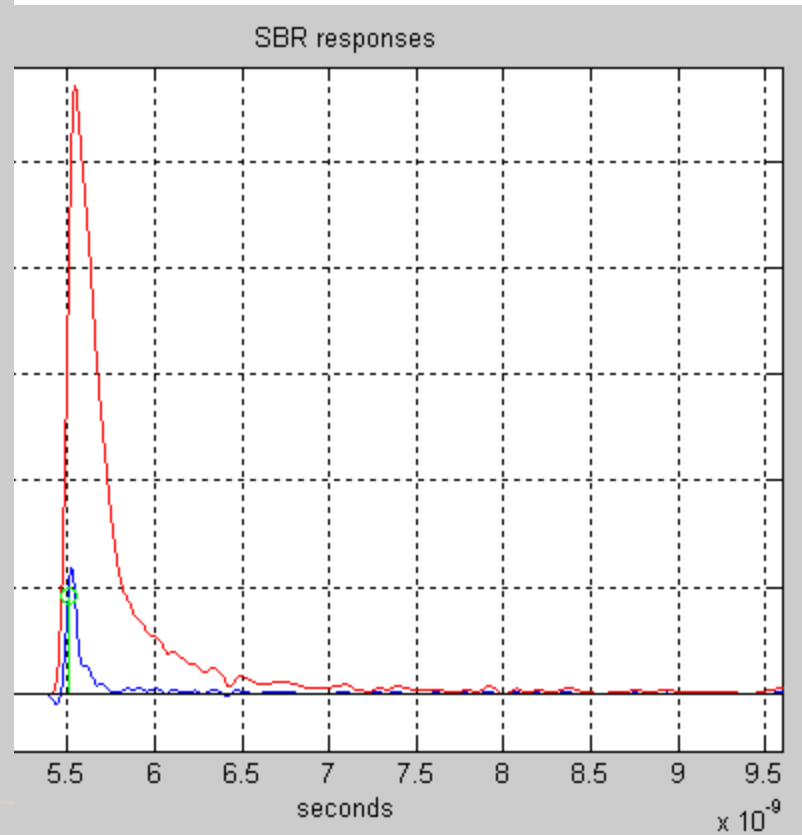
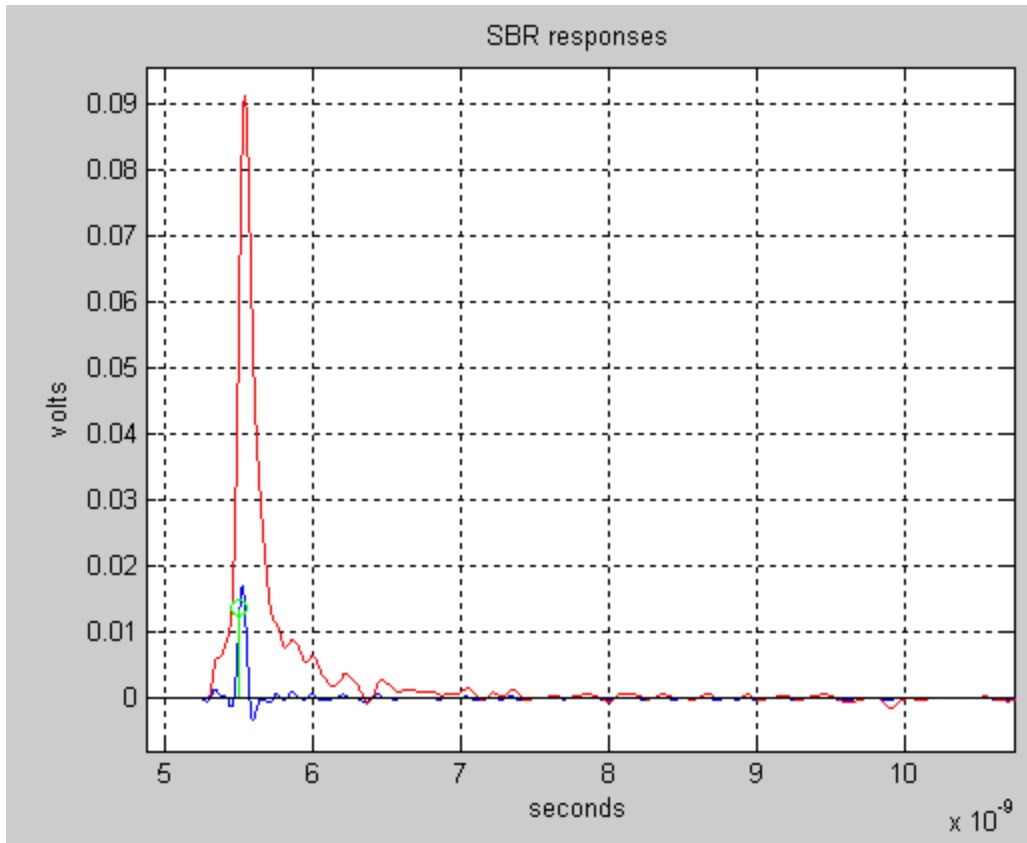
Next Steps / Follow up

- If decide to remove Rx PKG insertion loss:
Check the exact margin needed for Rx package and define COM accordingly. – A.I. – Liav.
- If decided to include Rx PKG IL, provide updated KP4 PKG model and consider updating the KR4 PKG IL model.
- Define exact COM numbers per interconnect for KR4 interference tolerance test.

Thank you

Backup slides

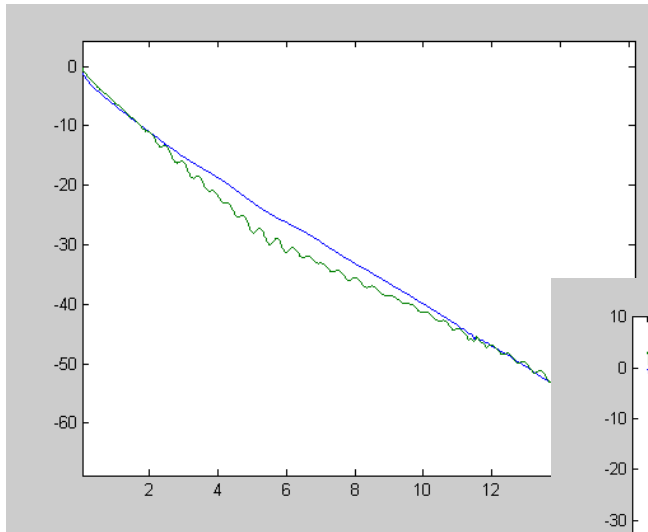
Non-Causal Behavior Removed



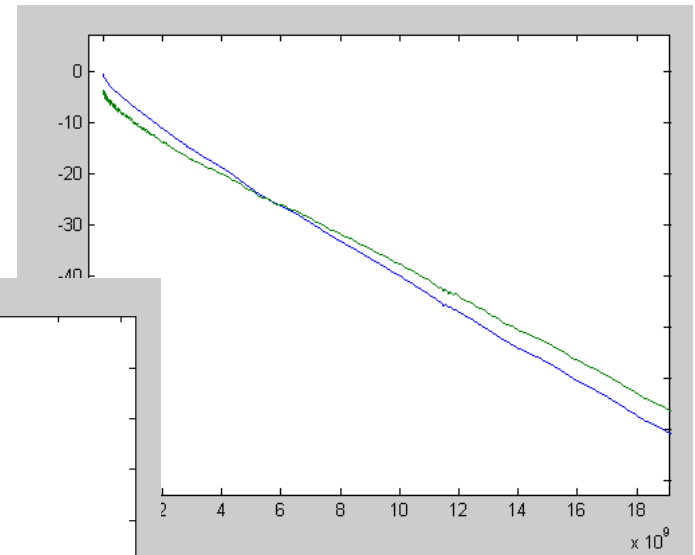
Gamma Frequency Domain Influence

- All analysis with $VTF=3$

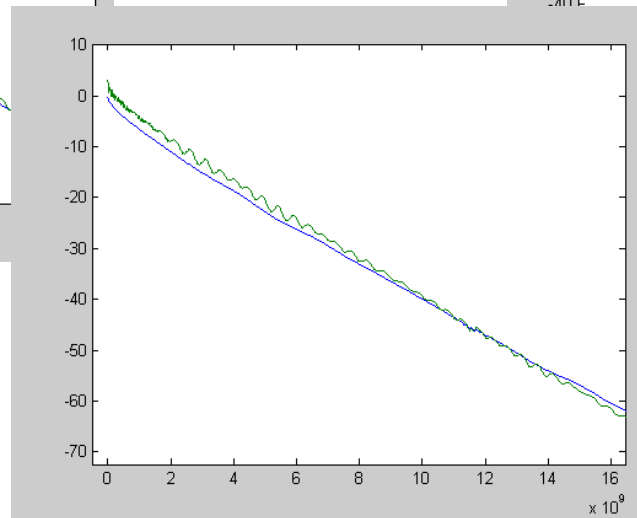
Suggested



Current COM code



Old Gamma



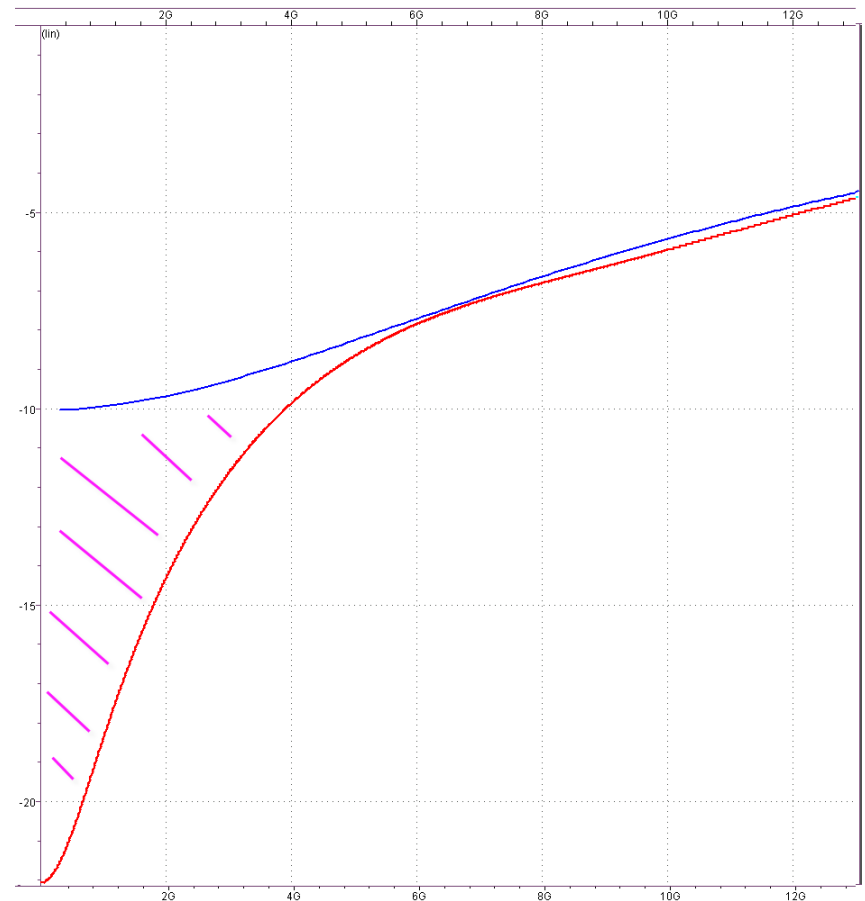
Correlated Synthetic Model as Ball

- A correlation was performed between HFSS extracted ball discontinuity and a synthetic model



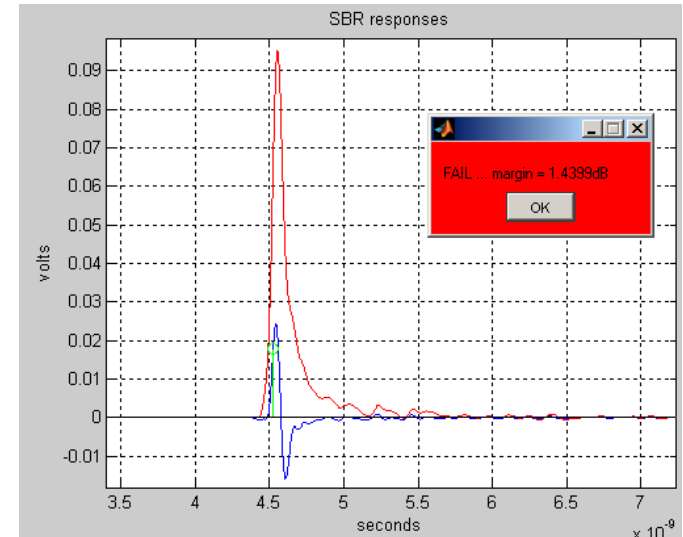
So what is wrong with the model?

- The package return loss equation did not represent the real reflection from a package, taking non reasonable margin at the low frequency.
- The package insertion loss was accounted for twice (Tx, Rx), while 800mV should be defined at TP0
 - ➔ If including a package IL model, include only Rx PKG insertion loss.



Main Observation @ $1e-12$ (return loss impact)

- Running the IBM 30dB interconnect – (meets the interconnect RL with minor violations) + OIF package / D1.2 package return loss returns a failing COM result w/o FEC.
- → Specifying the OIF targets as PKG and interconnect return loss limits does not guarantee a passing COM result.
 - Note: no package insertion loss model was included in the analysis.



Patel 30dB through interconnect

- “What if” analysis performed on the “Patel” 30dB through interconnect.

| PKG return loss | PKG insertion loss | Interconnect return loss | COM result |
|-----------------|--------------------|-----------------------------------|---|
| OIF | D1.2 | Original | 2.44dB (10^{-12}) |
| Slide #7 | D1.2 | Original | 2.48dB (10^{-12}) |
| Slide #7 | None | Original | 3.49dB (10^{-12}) |
| Slide #7 | D1.2 | Lower reflection magnitude by 20% | 3.05dB (10^{-12}) |
| Slide #7 | D1.2 | Original | 5.85dB (10^{-5}) |
| Slide #7 | D1.2 | Original | 4.88dB (10^{-5} & full Xtalk) |

IBM ~36dB interconnect

- “What if” analysis performed on 35db_Loss_channel.zip.

| PKG return loss | PKG insertion loss | Interconnect return loss | COM result |
|-----------------|--------------------|--------------------------|---|
| Slide #7 | D1.2 | Original | -2.22dB (10^{-12}) |
| Slide #7 | D1.2 | Original | 1.66dB (10^{-5}) |
| Slide #7 | D1.2 | Original | 3.21dB (10^{-5}) – Tweaking the Tx settings |
| Slide #7 | D1.2 | Magnitude lowered by 20% | 3.51dB (10^{-5}) – Tweaking the Tx settings |

- 6-9mV available signal is “scary” low...
- With very low signal every “minor” effect is magnified. This indicates a border line case putting us on an “edge of a cliff”
- Results indicate the PKG return loss and IL models are “good enough” to meet target.
- It is most important to verify that the interconnect provides the required COM value under worst case manufacturing tolerance.

Note: Post tap was limited to -0.2

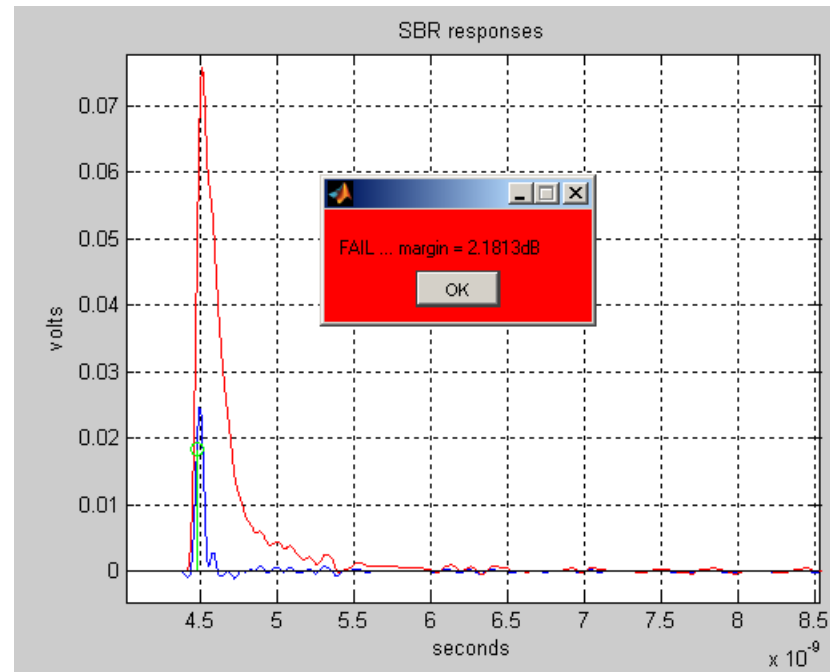
Strada Whisper Interconnects

- Running Strada Whisper interconnects with PKG RL, PKG IL and full XTalk. Modeling.

| Interconnect | PKG insertion loss | FEC (1e-12 / 1e-5) | COM result |
|------------------|--------------------|--------------------|------------|
| 42p8in - Meg6 | D1.2 | Yes | 6.4dB |
| 42p8in - Meg6 | D1.2 | No | 3.12dB |
| 29.8dB – Nelco 6 | D1.2 | Yes | 4.56dB |

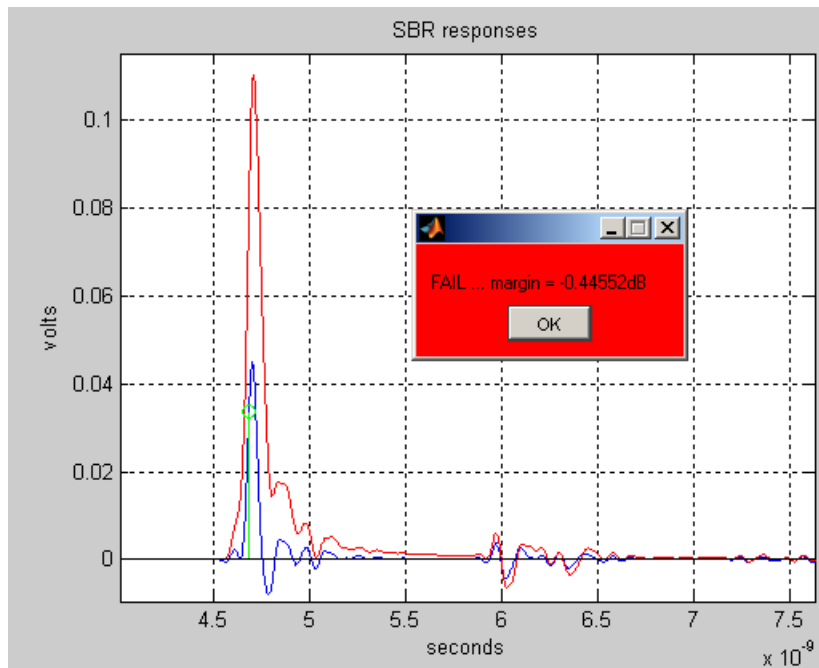
IBM30dB - An Improved PKG Return Loss

- Running the IBM 30dB channel with an improved (low frequency) PKG return loss (no PKG ins loss) returns a failing COM result (2.18dB)



FCI - Would a 200fF related PKG return loss help?

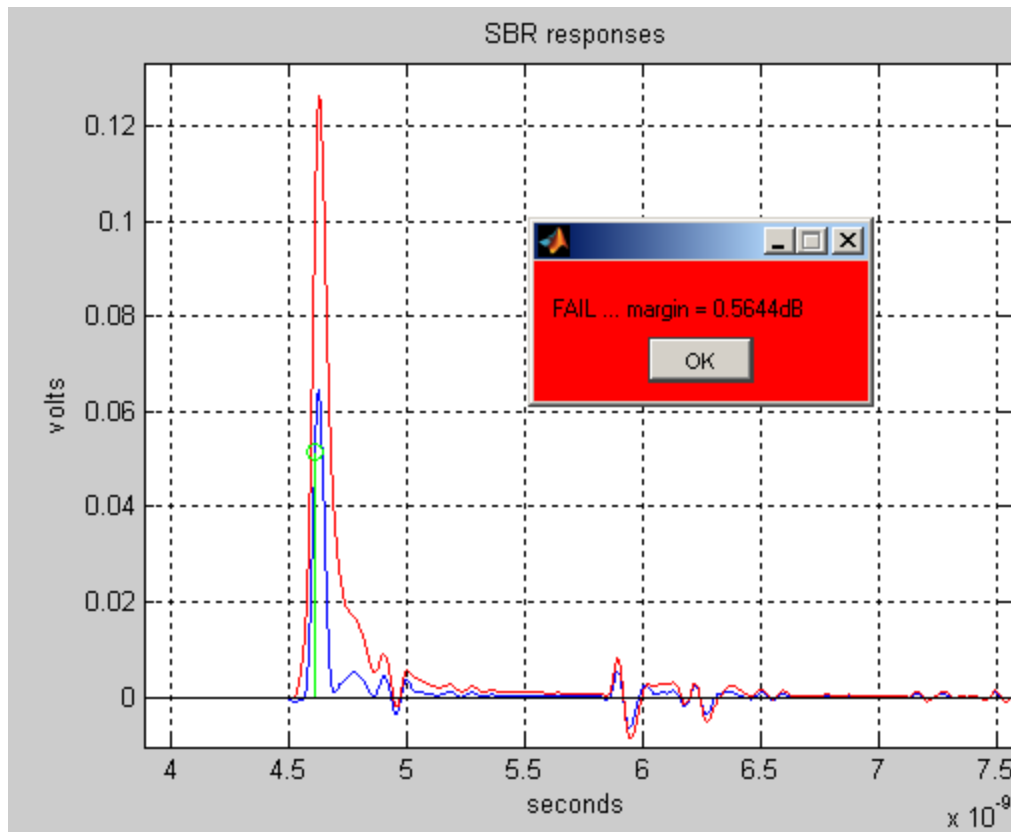
- Changing the PKG return loss to a “better” one that correlates to 200fF @ the die:



- No major effect...

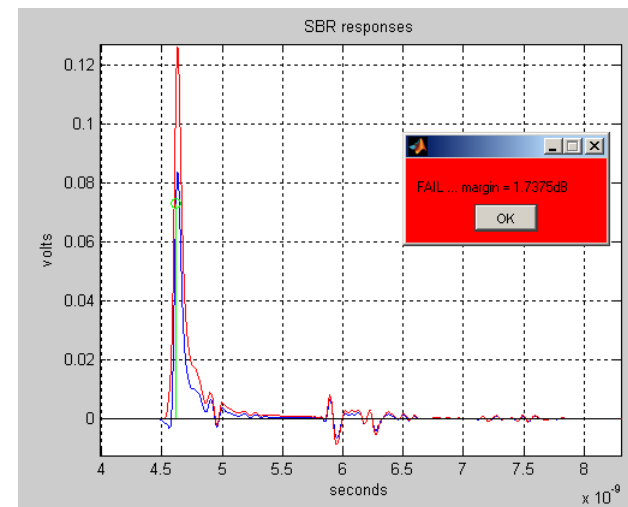
FCI - Is the PKG model the problem here?

- No! low effect of the PKG model



FCI - Pre-Cursor TAP Increased

- No PKG IL, Better PKG RL, pre-cursor tap limited to -0.3 instead of -0.1...
- Still not enough...
- Most of the analysis was performed with VTF = 1 (which is easier), but still it was not enough...
Will be discussed on a later slide.



- *Conclusion: Need to tighten Return loss or rely on FEC...*

What is the amount of needed COM margin?

- Based on ran_01_0712.pdf (Adee Ran – July 2012)

COM calculation

$$\text{COM} = 20 * \log_{10}(\text{S/I}_{\text{peak}}) - \text{Allowance}$$

- Allowance set to 8 dB, comprised of:
 - ~~2 dB for TX jitter & distortion~~ **Integrated in the code**
 - 1.5 dB for RX jitter & distortion
 - 1.5 dB for RX sensitivity
 - 3 dB for RX package loss and xtalk effects
 - Can be reduced with **more accurate package model** **Integrated in the code**
- **Final allowance factors may vary**
 - **May also be different for NRZ and PAM4**